

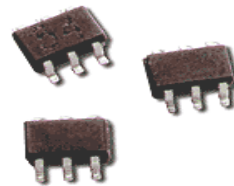
MGA-85563

3V LNA, 12 to 17dBm Adjustable OIP3, 0.8-6GHz, SOT363 (SC-70)

Description



Lifecycle status: **Active**



Features

The MGA-85 is a 3V part with high gain and low noise figure. It is housed in the miniature SOT-363 package and designed for 3V low noise amplifier applications. Bias: 3V, 15-30mA (adjustable); Gain = 18dB; NF = 1.6dB; P1dB = 1 to 9dBm (adjustable); IP3i = -6 to 0dB (adjustable) all at 2GHz.

MGA-85563

3-volt, Low Noise Amplifier for 0.8–6 GHz Applications



Data Sheet

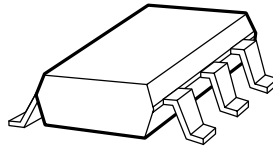
Description

Avago's MGA-85563 is an easy-to-use GaAs RFIC amplifier that offers low noise figure and high gain from 0.8 to 6 GHz. Packaged in an ultra-miniature SOT-363 package, it requires half the board space of a SOT-143 package.

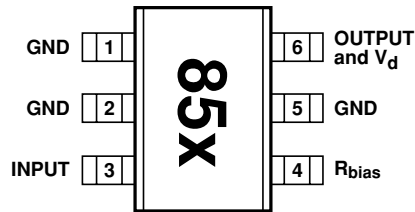
The MGA-85563 features a minimum noise figure of 1.6 dB and associated gain of 18 dB at 1.9 GHz. The output is matched internally to 50Ω , and the input is partially matched, requiring only a single external inductor for optimal performance. The supply current can be adjusted using an external resistor, varying IP3 from +12 dBm to +17 dBm.

The circuit uses state-of-the-art PHEMT technology with proven reliability. On-chip bias circuitry allows operation from a single +3 V supply, while resistive feedback ensures stability ($K > 1$) over frequency and temperature.

Surface Mount Package SOT-363 (SC-70)

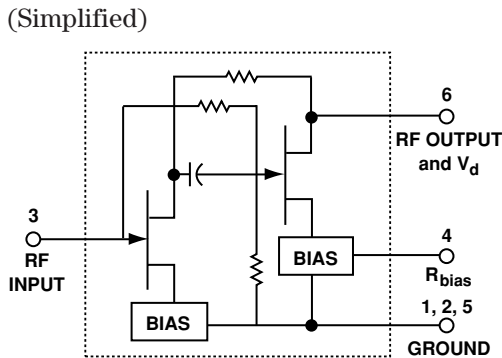


Pin Connections and Package Marking



Note:
Package marking provides orientation and identification; "x" is date code.

Equivalent Circuit (Simplified)



Features

- Lead-free Option Available
- 1.6 dB minimum Noise Figure at 1.9 GHz
- Adjustable IP3 from +12 dBm to +17 dBm via External Resistor
- 18 dB Gain at 1.9 GHz
- Single 3 V Supply
- Unconditionally Stable

Applications

- Amplifier for Cellular, PCS, and Wireless LAN Applications



Attention:
Observe precautions for handling electrostatic sensitive devices.

ESD Machine Model (Class A)

ESD Human Body Model (Class 0)

Refer to Avago Application Note A004R: Electrostatic Discharge Damage and Control.

MGA-85563 Absolute Maximum Ratings

Symbol	Parameter	Units	Absolute Maximum ^[1]
V_d, \max	Maximum Device Voltage	V	5.5
P_{in}	CW RF Input Power	dBm	+13
T_{ch}	Channel Temperature	°C	150
T_{STG}	Storage Temperature	°C	-65 to 150

Thermal Resistance^[2]:

$$\theta_{ch \text{ to } c} = 155^{\circ}\text{C/W}$$

Notes:

1. Operation of this device above any one of these limits may cause permanent damage.
2. $T_C = 25^{\circ}\text{C}$ (T_C is defined to be the temperature at the package pins where contact is made to the circuit board).

Electrical Specifications, $T_C = 25^{\circ}\text{C}$, $Z_0 = 50 \Omega$, $V_d = 3 \text{ V}$, and using default of no external resistor at the R_{bias} pin

Symbol	Parameters and Test Conditions	Units	Min.	Typ.	Max.	Std. Dev. ^[3]
G_{test}	Gain in Test Circuit ^[1]	f = 2.0 GHz	dB	16	19	1.0
NF_{test}	Noise Figure in Test Circuit ^[1]	f = 2.0 GHz	dB		1.85	2.3
NF_{MIN}	Minimum Noise Figure (measured with G_{opt} presented to the input and 50Ω presented to the output)	f = 0.9 GHz f = 1.5 GHz f = 2.0 GHz f = 2.4 GHz f = 4.0 GHz f = 5.0 GHz f = 6.0 GHz	dB		1.6 1.6 1.6 1.6 1.6 1.6 1.6	0.1
G_A	Associated Gain at NF_{MIN} (measured with G_{opt} presented to the input and 50Ω presented to the output)	f = 0.9 GHz f = 1.5 GHz f = 2.0 GHz f = 2.4 GHz f = 4.0 GHz f = 5.0 GHz f = 6.0 GHz	dB		17.0 17.5 18.0 18.5 17.5 16.0 14.5	1.0
IP_3	Third Order Intercept Point (measured with 50Ω presented to the input and output)	f = 0.9 GHz f = 1.5 GHz f = 2.0 GHz f = 2.4 GHz f = 4.0 GHz f = 5.0 GHz f = 6.0 GHz	dBm		13 13 11.5 11.5 13 12.5 12	1.2
$P_{1 \text{ dB}}$	Output Power at 1 dB Gain Compression (measured with 50Ω presented to the input and output)	f = 0.9 GHz f = 1.5 GHz f = 2.0 GHz f = 2.4 GHz f = 4.0 GHz f = 5.0 GHz f = 6.0 GHz	dBm		0.8 0.9 0.9 1.0 1.4 1.3 1.2	1.1

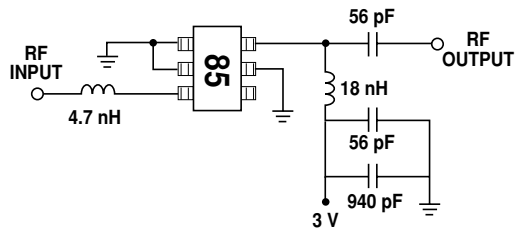
MGA-85563 Electrical Specifications, continued, $T_C = 25^\circ\text{C}$, $Z_0 = 50\ \Omega$, $V_d = 3\ \text{V}$, and using default of no external resistor at the R_{bias} pin

Symbol	Parameters and Test Conditions	Units	Min.	Typ.	Max.	Std. Dev. ^[3]
VSWR_{in}	Input VSWR ^[2]			2.5:1		
VSWR_{out}	Output VSWR ^[2]			1.3:1		
ISOL	Isolation	$f = 0.9 - 3.0\ \text{GHz}$		37		0.6
		$f = 3.0 - 6.0\ \text{GHz}$		30		
I_d	Device Current	mA		15	20	1.9

Notes:

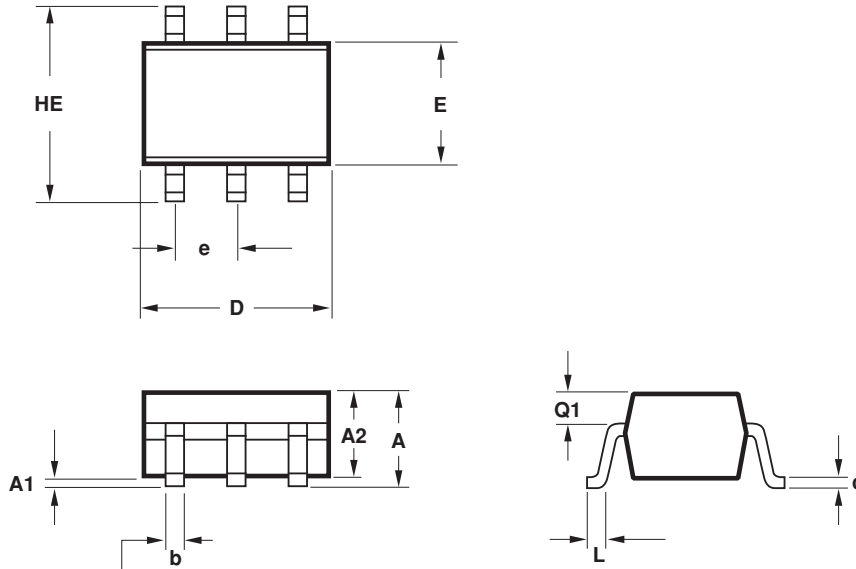
1. Guaranteed specifications are 100% tested in the circuit of Figure 1.
2. Measured using the final test circuit shown below at $f = 2\ \text{GHz}$.
3. Standard Deviation number is based on measurement of at least 500 parts from three non-consecutive wafer lots during the initial characterization of this product, and is intended to be used as an estimate for distribution of the typical specification.

MGA-85563 Final Test Circuit, $T_C = 25^\circ\text{C}$, $Z_0 = 50\ \Omega$



Package Dimensions

Outline 63 (SOT-363/SC-70)



SYMBOL	DIMENSIONS (mm)	
	MIN.	MAX.
E	1.15	1.35
D	1.80	2.25
HE	1.80	2.40
A	0.80	1.10
A2	0.80	1.00
A1	0.00	0.10
Q1	0.10	0.40
e	0.650 BCS	
b	0.15	0.30
c	0.10	0.20
L	0.10	0.30

NOTES:

- All dimensions are in mm.
- Dimensions are inclusive of plating.
- Dimensions are exclusive of mold flash & metal burr.
- All specifications comply to EIAJ SC70.
- Die is facing up for mold and facing down for trim/form, ie: reverse trim/form.
- Package surface to be mirror finish.

Part Number Ordering Information

Part Number	No. of Devices	Container
MGA-85563-TR1	3000	7" Reel
MGA-85563-TR2	10000	13" Reel
MGA-85563-BLK	100	antistatic bag
MGA-85563-TR1G	3000	7" Reel
MGA-85563-TR2G	10000	13" Reel
MGA-85563-BLKG	100	antistatic bag

Note: For lead-free option, the part number will have the character "G" at the end.